

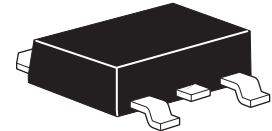
ZXMP7A17K

70V P-channel enhancement mode MOSFET

Summary

$V_{DSS}=70V : R_{DS(on)}=0.16\Omega$

$I_D=5.7A$

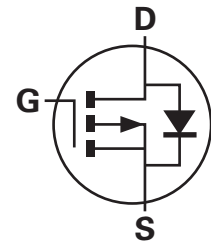


Description

This new generation of trench MOSFETs from Zetex utilizes a unique structure that combines the benefits of low on-resistance with fast switching speed. This makes them ideal for high efficiency, low voltage power management applications.

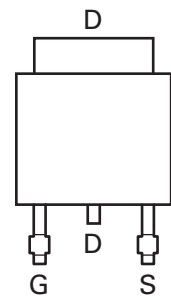
Features

- Low on-resistance
- Fast switching speed
- Low threshold
- Low gate drive
- DPAK package



Applications

- DC-DC converters
- Power management functions
- Disconnect switches
- Motor control
- Class D audio output stages



Pinout - top view

Ordering information

Device	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXMP7A17KTC	13	16	2,500

Device marking

ZXMP
7A17

Absolute maximum ratings

Parameter	Symbol	Limit	Unit
Drain-source voltage	V_{DSS}	-70	V
Gate-source voltage	V_{GS}	± 20	V
Continuous drain current @ $V_{GS}=10V$; $T_A=25^\circ C$ ^(b) @ $V_{GS}=10V$; $T_A=25^\circ C$ ^(b) @ $V_{GS}=10V$; $T_A=25^\circ C$ ^(a)	I_D	-5.7 -4.6 -3.8	A
Pulsed drain current ^(c)	I_{DM}	-17.7	A
Continuous source current (body diode) ^(b)	I_S	-9.2	A
Pulsed source current (body diode) ^(c)	I_{SM}	-17.7	A
Power dissipation at $T_A = 25^\circ C$ ^(a) Linear derating factor	P_D	4.17 33.3	W mW/°C
Power dissipation at $T_A = 25^\circ C$ ^(b) Linear derating factor	P_D	9.25 74	W mW/°C
Power dissipation at $T_A = 25^\circ C$ ^(d) Linear derating factor	P_D	2.11 16.8	W mW/°C
Operating and storage temperature range	T_j, T_{stg}	-55 to +150	°C

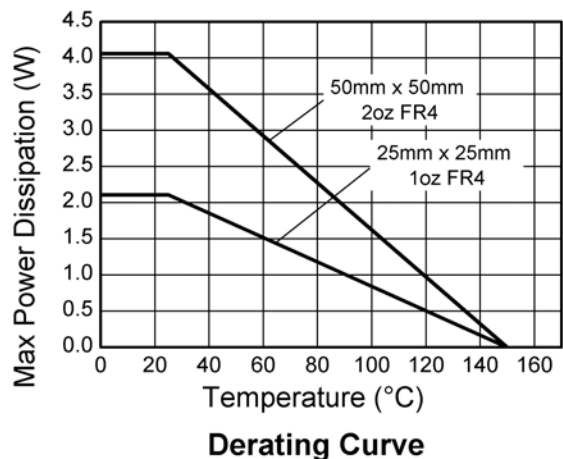
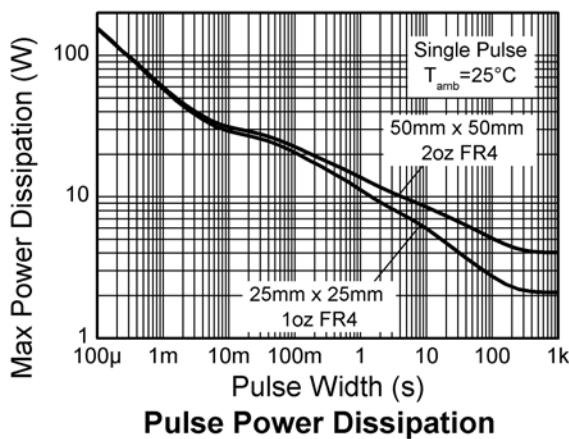
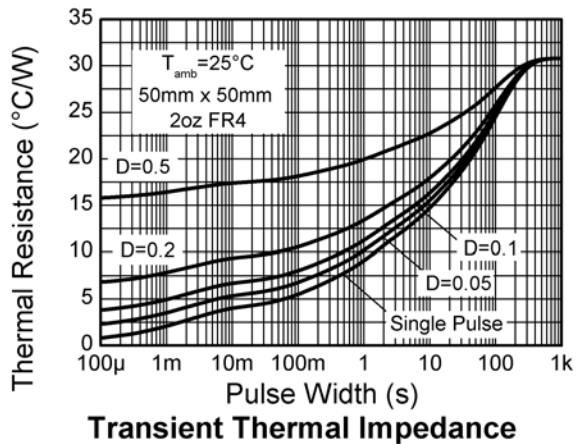
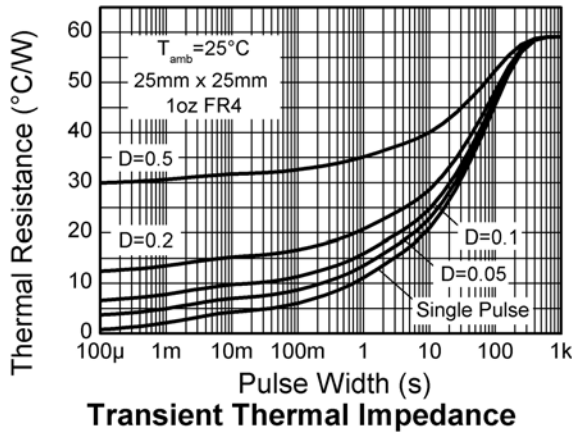
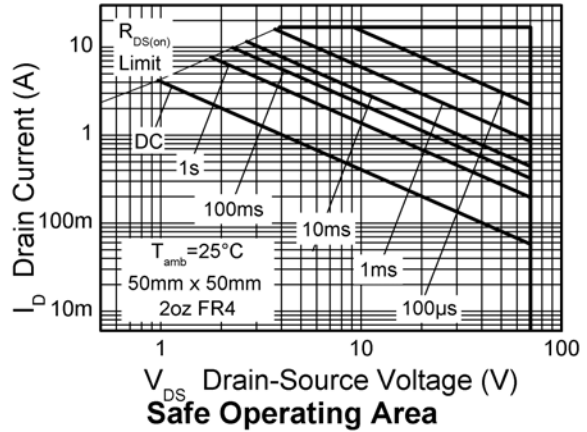
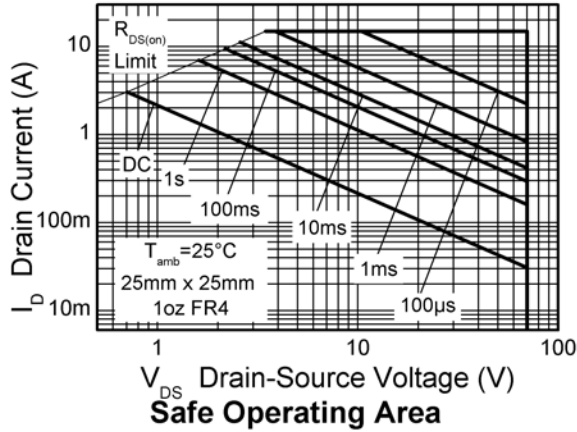
Thermal resistance

Parameter	Symbol	Limit	Unit
Junction to ambient ^(a)	$R_{\theta JA}$	30	°C/W
Junction to ambient ^(b)	$R_{\theta JA}$	13.5	°C/W
Junction to ambient ^(c)	$R_{\theta JA}$	59.1	°C/W

NOTES:

- (a) For a device surface mounted on 50mm x 50mm x 1.6mm FR4 PCB with high coverage of single sided 2oz copper, in still air conditions.
- (b) For a device surface mounted on FR4 PCB measured at $t \leq 10$ sec.
- (c) Repetitive rating 50mm x 50mm x 1.6mm FR4 PCB, $D=0.02$ pulse width=300 μs - pulse width limited by maximum junction temperature.
- (d) For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.

Characteristics



ZXMP7A17K

ELECTRICAL CHARACTERISTICS (at Tamb = 25°C unless otherwise stated)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Static						
Drain-source breakdown voltage	$V_{(BR)DSS}$	-70			V	$I_D = -250\mu A, V_{GS} = 0V$
Zero gate voltage drain current	I_{DSS}			-1	μA	$V_{DS} = -70V, V_{GS} = 0V$
Gate-body leakage	I_{GSS}			100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
Gate-source threshold voltage	$V_{GS(th)}$	-1.0			V	$I_D = -250\mu A, V_{DS} = V_{GS}$
Static drain-source on-state resistance ^(*)	$R_{DS(on)}$			0.16	Ω	$V_{GS} = -10V, I_D = -2.1A$
				0.25	Ω	$V_{GS} = -4.5V, I_D = -1.7A$
Forward transconductance ^{(*)(‡)}	g_{fs}		4.4		S	$V_{DS} = -15V, I_D = -2.1A$
Dynamic^(‡)						
Input capacitance	C_{iss}		635		pF	$V_{DS} = -40V, V_{GS} = 0V$ $f = 1MHz$
Output capacitance	C_{oss}		52		pF	
Reverse transfer capacitance	C_{rss}		42.5		pF	
Switching^{(†)(‡)}						
Turn-on-delay time	$t_{d(on)}$		2.5		ns	$V_{DD} = -35V, I_D = -1A$ $R_G = 6.0\Omega, V_{GS} = -10V$
Rise time	t_r		3.4		ns	
Turn-off delay time	$t_{d(off)}$		27.9		ns	
Fall time	t_f		8		ns	
Total gate charge	Q_g		9.6		nC	$V_{DS} = -35V, V_{GS} = -5V$ $I_D = -2.1A$
Total gate charge	Q_g		18		nC	$V_{DS} = -35V, V_{GS} = -10V$ $I_D = -2.1A$
Gate-source charge	Q_{gs}		1.77		nC	
Gate drain charge	Q_{gd}		3.66		nC	
Source-drain diode						
Diode forward voltage ^(*)	V_{SD}		-0.85	-0.95	V	$T_j = 25^\circ C, I_S = -2.0A,$ $V_{GS} = 0V$
Reverse recovery time ^(‡)	t_{rr}		29.8		ns	$T_j = 25^\circ C, I_S = -2.1A,$ $di/dt = 100A/\mu s$
Reverse recovery charge ^(‡)	Q_{rr}		38.5		nC	

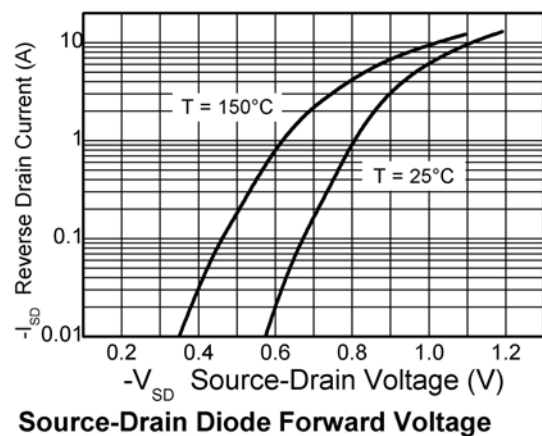
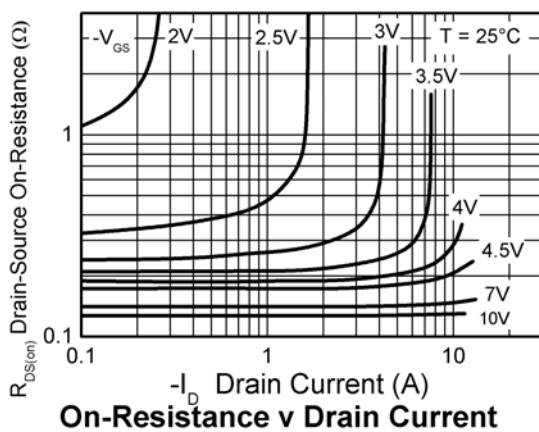
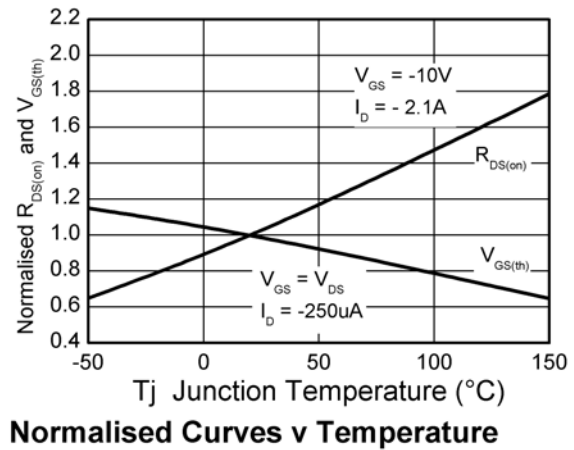
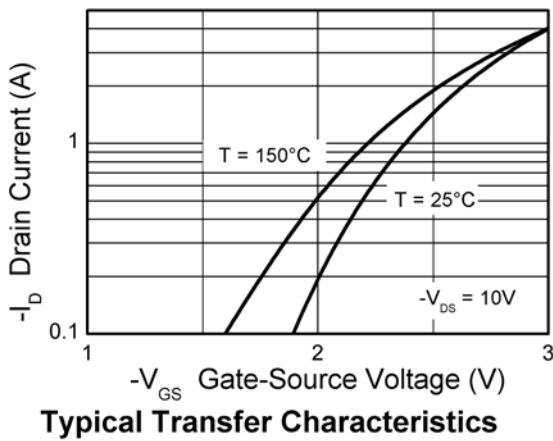
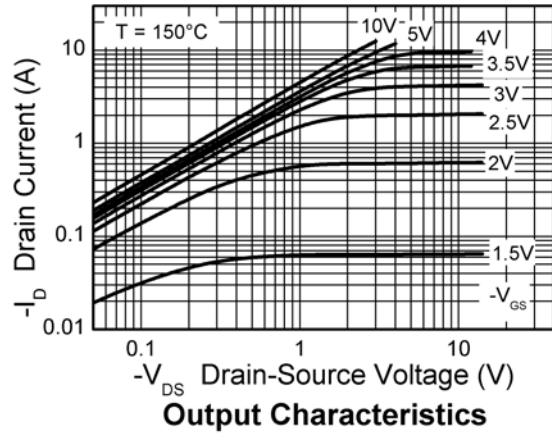
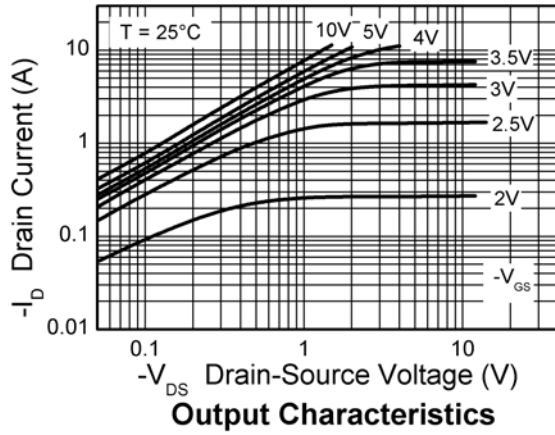
NOTES:

(*) Measured under pulsed conditions. Pulse width $\leq 300\mu s$; duty cycle $\leq 2\%$.

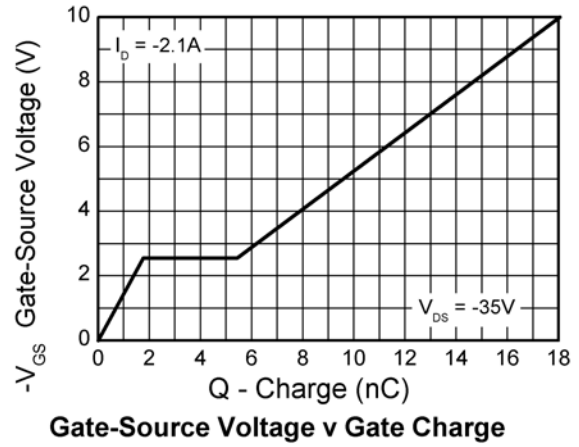
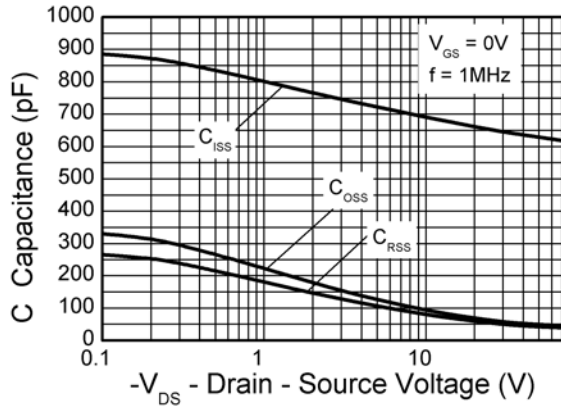
(†) Switching characteristics are independent of operating junction temperature.

(‡) For design aid only, not subject to production testing.

Typical characteristics



Typical characteristics

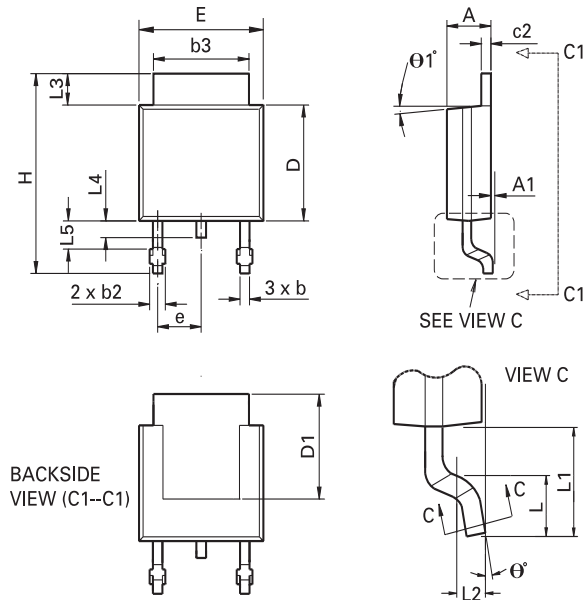


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Package outline - DPAK



DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min	Max	Min	Max		Min	Max	Min	Max
A	0.086	0.094	2.18	2.39	e	0.090 BSC		2.29 BSC	
A1	-	0.005	-	0.127	H	0.370	0.410	9.40	10.41
b	0.020	0.035	0.508	0.89	L	0.055	0.070	1.40	1.78
b2	0.030	0.045	0.762	1.14	L1	0.108 REF		2.74 REF	
b3	0.205	0.215	5.21	5.46	L2	0.020 BSC		0.508 BSC	
c	0.018	0.024	0.457	0.61	L3	0.035	0.065	0.89	1.65
c2	0.018	0.023	0.457	0.584	L4	0.025	0.040	0.635	1.016
D	0.213	0.245	5.41	6.22	L5	0.045	0.060	1.14	1.52
D1	0.205	-	5.21	-	theta 1°	0°	10°	0°	10°
E	0.250	0.265	6.35	6.73	theta 2°	0°	15°	0°	15°
E1	0.170	-	4.32	-	-	-	-	-	-

Note: Controlling dimensions are in inches. Approximate dimensions are provided in millimeters

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